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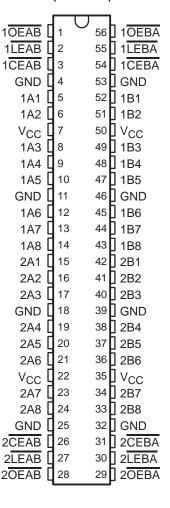
- **Members of the Texas Instruments** *Widebus*™ Family
- Inputs Are TTL-Voltage Compatible
- **3-State Inverted Outputs**
- Flow-Through Architecture Optimizes **PCB Layout**
- Distributed V_{CC} and GND Pin Configuration **Minimizes High-Speed Switching Noise**
- **EPIC™** (Enhanced-Performance Implanted CMOS) 1-µm Process
- 500-mA Typical Latch-Up Immunity at 125°C
- Package Options Include Plastic 300-mil Shrink Small-Outline (DL) Packages Using 25-mil Center-to-Center Pin Spacings and 380-mil Fine-Pitch Ceramic Flat (WD) Packages Using 25-mil Center-to-Center **Pin Spacings**

description

The 'ACT16544 are 16-bit registered transceivers that contain two sets of D-type latches for temporary storage of data flowing in either direction. They can be used as two 8-bit transceivers or one 16-bit transceiver. Separate latch-enable (LEAB or LEBA) and output-enable (OEAB or OEBA) inputs are provided for each register to permit independent control in either direction of data flow.

The A-to-B enable (CEAB) input must be low to enter data from A or to output data to B. Having CEAB low and LEAB low makes the A-to-B latches transparent; a subsequent low-to-high transition at LEAB puts the A latches in the storage mode. Data flow from B to A is similar, but requires using the CEBA, LEBA, and OEBA inputs.

54ACT16544...WD PACKAGE 74ACT16544 . . . DL PACKAGE (TOP VIEW)



The 74ACT16544 is packaged in TI's shrink small-outline package, which provides twice the I/O pin count and functionality of standard small-outline packages in the same printed-circuit-board area.

The 54ACT16544 is characterized for operation over the full military temperature range of -55°C to 125°C. The 74ACT16544 is characterized for operation from -40°C to 85°C.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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54ACT16544, 74ACT16544 16-BIT REGISTERED TRANSCEIVERS WITH 3-STATE OUTPUTS SCAS161A – AUGUST 1990 – REVISED APRIL 1996

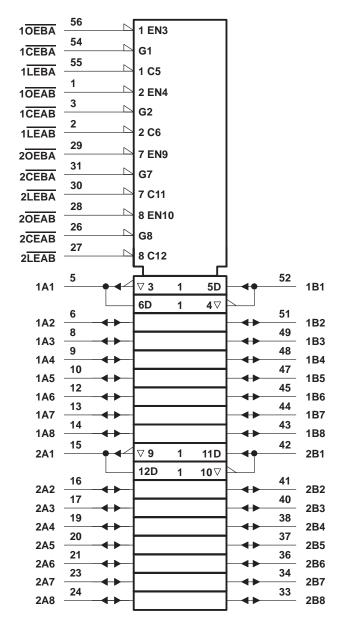
FUNCTION TABLE†

	OUTPUT			
CEAB	LEAB	OEAB	Α	В
Н	Х	Х	Х	Z
L	X	Н	X	Z
L	Н	L	X	в ₀ ‡
L	L	L	L	Н
L	L	L	Н	L

[†] A-to-B data flow is shown: B-to-A flow control is the same except that it uses CEBA, LEBA, and OEBA. ‡ Output level before the indicated steady-state input conditions were established

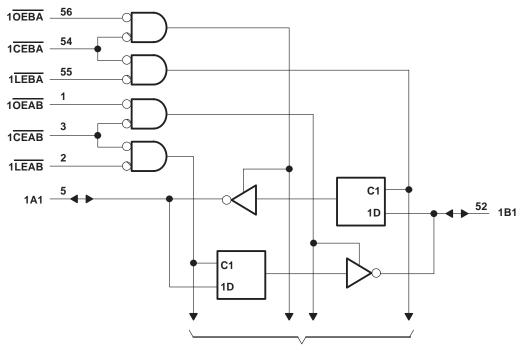


logic symbol†

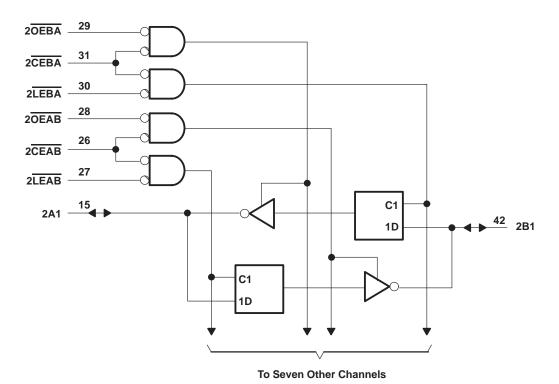


[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



To Seven Other Channels



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}	0.5 to 7 V
Input voltage range, V _I (see Note 1)	. -0.5 to V_{CC} + 0.5 V
Input voltage range, V _O (see Note 1)	. -0.5 to V_{CC} + 0.5 V
Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$)	±20 mA
Output clamp current, I _{OK} (V _O < 0 or V _O > V _{CC})	±50 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC})	±50 mA
Continuous current through V _{CC} or GND	±400 mA
Maximum power package dissipation at $T_A = 55^{\circ}C$ (see Note 2): DL package	1.4 W
Storage temperature range, T _{stq}	–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions (see Note 3)

		54ACT16544		74ACT16544			UNIT	
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	2	4	~h	2			V
VIL	Low-level input voltage		S	0.8			0.8	V
٧ _I	Input voltage	0	Q	VCC	0		VCC	V
Vo	Output voltage	0	Ç	VCC	0		VCC	V
loh	High-level output current	4	2	-24			-24	mA
loL	Low-level output current) V	,	24			24	mA
Δt/Δν	Input transition rise or fall rate	0		10	0		10	ns/V
TA	Operating free-air temperature	-55		125	-40		85	°C

NOTE 3: Unused inputs must be held high or low to prevent them from floating.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

^{2.} The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils.

54ACT16544, 74ACT16544 16-BIT REGISTERED TRANSCEIVERS WITH 3-STATE OUTPUTS

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	V	T,	<u> </u> = 25°C		54ACT	16544	74ACT16544		UNIT
		TEST CONDITIONS	VCC	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNII
		10.1 - 50.11A	4.5 V	4.4			4.4		4.4		
		I _{OH} = -50 μA	5.5 V	5.4			5.4		5.4		
Vон		1011 - 24 mA	4.5 V	3.94			3.8		3.8		V
		I _{OH} = -24 mA	5.5 V	4.94			4.8		4.8		
		I _{OH} = -75 mA [†]	5.5 V				3.85	N.	3.85		
		10. – 50 uA	4.5 V			0.1		0.1		0.1	V
		I _{OL} = 50 μA	5.5 V			0.1	4	0.1		0.1	
VOL		Jan. 24 mA	4.5 V			0.36	6	0.44		0.44	
		I _{OL} = 24 mA	5.5 V			0.36	20	0.44		0.44	
		I _{OL} = 75 mA [†]	5.5 V				80	1.65		1.65	
II	Control inputs	V _I = V _{CC} or GND	5.5 V			±0.1	y	±1		±1	μΑ
loz‡	A or B ports	V _O = V _{CC} or GND	5.5 V			±0.5		±5		±5	μΑ
Icc		$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V			8		80		80	μΑ
Δl _{CC} §		One input at 3.4 V, Other inputs at V _{CC} or GND	5.5 V			0.9		1		1	mA
Ci	Control inputs	V _I = V _{CC} or GND	5 V		4.5						pF
C _{io}	A or B ports	$V_O = V_{CC}$ or GND	5 V		12						pF

T Not more than one output should be tested at a time, and the duration of the test should not exceed 10 ms.

timing requirements over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

			$T_A = 2$	25°C	54ACT	16544	74ACT	16544	UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	ONIT
t _W	Pulse duration	LEAB or LEBA low	5.5		5.5	4	5.5		ns
	Setup time	Data before LEAB or LEBA↑			1.5	N.J.	1.5		no
t _{su}	Setup time	Data before CEAB or CEBA↑	1.5		1.5	3/1/	1.5		ns
4.	Hold time	Data after LEAB or LEBA↑	3		3		3		20
th	Hold tille	Data after CEAB or CEBA↑	3		3		3		ns

[‡] For I/O ports, the parameter IOZ includes the input leakage current.

[§] This is the increase in supply current for each input that is at one of the specified TTL voltage levels rather than 0 V or VCC.

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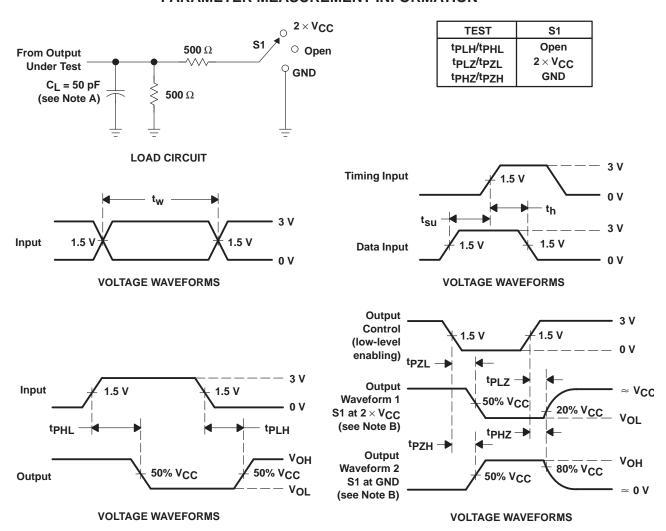
switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	T,	ղ = 25°C	;	54ACT	16544	74ACT	16544	UNIT
PARAMETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
^t PLH	A or B	B or A	2.8	6.7	10	2.8	11.2	2.8	11.2	ns
^t PHL	AOIB	BOIA	4	7.5	10	4	11.2	4	11.2	115
^t PLH	LEDALEAD	A or B	2.7	9	13.3	2.7	14	2.7	14	20
t _{PHL}	LEBA or LEAB	AUIB	2.8	8.5	12.1	2.8	13.5	2.8	13.5	ns
^t PZH	<u> </u>	A or B	3.2	7.2	10.5	3.2	11.7	3.2	11.7	ns
tPZL	CEBA or CEAB		3.8	8.2	12	3.8	13.6	3.8	13.6	115
^t PHZ	CEBA or CEAB	A or B	5.8	8.2	10.3	5.8	11.1	5.8	11.1	ns
t _{PLZ}	CEBA OF CEAB	AOIB	5	7.4	9.4	5	10.2	5	10.2	115
^t PZH	<u> </u>	A or B	2.8	6.9	10.2	2.8	11.4	2.8	11.4	20
t _{PZL}	OEBA or OEAB	AUIB	3.6	7.9	11.7	3.6	13.3	3.6	13.3	ns
^t PHZ	OFDA or OFAD	A or B	5.2	7.7	9.8	5.2	10.5	5.2	10.5	ns
t _{PLZ}	OEBA or OEAB	A OL R	3.4	6.8	8.8	3.4	9.6	3.4	9.6	115

operating characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

PARAMETER				TEST CONDITIONS		
	Power discipation capacitance per transcriver	Outputs enabled	C 50 pE	f = 1 MHz	60	n.E
C _{pd} Power dissipation capacitance per transceiver	Outputs disabled	C _L = 50 pF,	1 = 1 IVITZ	13	pF	

PARAMETER MEASUREMENT INFORMATION



- NOTES: A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_O = 50 \Omega$, $t_f = 3 \text{ ns}$, $t_f = 3 \text{ ns}$.
 - D. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms







24-Jun-2005

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
74ACT16544DL	OBSOLETE	SSOP	DL	56	TBD	Call TI	Call TI
74ACT16544DLR	OBSOLETE	SSOP	DL	56	TBD	Call TI	Call TI

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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